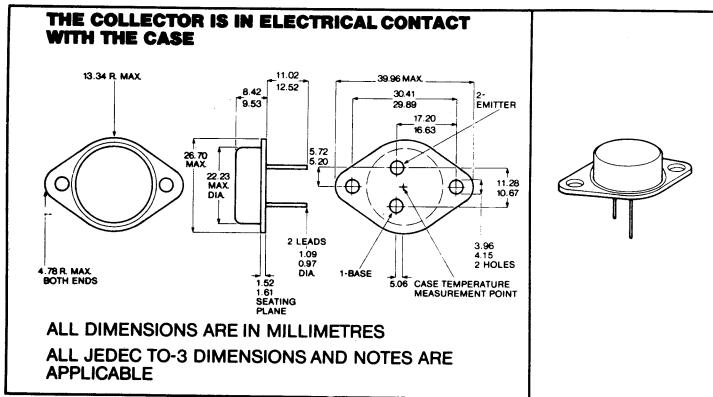


**TYPES 2N6326, 2N6327, 2N6328
N-P-N SILICON POWER TRANSISTORS**

FOR POWER-AMPLIFIER AND HIGH-SPEED-SWITCHING APPLICATIONS DESIGNED FOR COMPLEMENTARY USE WITH 2N6329, 2N6330, 2N6331

- 200 W at 25°C Case Temperature
 - 30-A Rated Collector Current
 - 200-mJ Reverse Energy Rating
 - High SOA Capability, 20 V and 10 A

*mechanical data



***absolute maximum ratings at 25°C case temperature (unless otherwise noted)**

	2N6326	2N6327	2N6328
Collector-Base Voltage	60 V	80 V	100 V
Collector-Emitter Voltage (See Note 1)	60 V	80 V	100 V
Emitter-Base Voltage	5 V	5 V	5 V
Continuous Collector Current	30 A		
Peak Collector Current (See Note 2)	40 A		
Continuous Base Current	10 A		
Safe Operating Areas at (or below) 25°C Case Temperature	See Figures 3 and 4		
Continuous Device Dissipation at (or below) 25°C Case Temperature (See Note 3)	200 W		
Continuous Device Dissipation at 100°C Case Temperature (See Note 3)	114 W		
Continuous Device Dissipation at (or below) 25°C Free-Air Temperature (See Note 4)	5 W		
Unclamped Inductive Load Energy (See Note 5)	200 mJ		
Operating Collector Junction Temperature Range	-65°C to 200°C		
Storage Temperature Range	-65°C to 200°C		
Terminal Temperature 1.6 mm from Case for 10 Seconds	250°C		

NOTES: 1. These values apply when the base-emitter diode is open-circuited.

2. This value applies for $t_w \leq 1$ ms, duty cycle $\leq 10\%$.

3. Derate linearly to 200°C case temperature at the rate of 1.14 W/°C or refer to Dissipation Derating Curve, Figure 5.

4. Derate linearly to 200°C free-air temperature at the rate of 11.1°C/C or refer to Dissipation Derating Curve, Figure 5.

5. This rating is based on the capability of the transistors to operate safely in the circuit of Figure 2. $I_c = 20 \text{ mA}$, $R_{on} = 10 \Omega$.

The following is based on the capability of the transistors to operate safely in the circuit of Figure 2. $L = 20 \text{ mH}$, $R_{BB2} = 100 \Omega$, $V_{BR2} = 0 \text{ V}$, $R_s = 0.1 \Omega$, $V_{CC} = 20 \text{ V}$. Energy $\approx I_C^2 L / 2$.

*JEDEC registered data. This data sheet contains all applicable registered data in effect at the time of publication.

TEXAS INSTRUMENTS

TYPES 2N6326, 2N6327, 2N6328 N-P-N SILICON POWER TRANSISTORS

*electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	2N6326		2N6327		2N6328		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
V(BR)CEO Collector-Emitter Breakdown Voltage	I _C = 30 mA, I _B = 0, See Note 6	60		80		100		V
I _{CEO} Collector Cutoff Current	V _{CE} = 30 V, I _B = 0		1					mA
	V _{CE} = 40 V, I _B = 0			1				
	V _{CE} = 50 V, I _B = 0				1			
	V _{CE} = 60 V, V _{BE} = 0		0.5					
I _{CES} Collector Cutoff Current	V _{CE} = 80 V, V _{BE} = 0			0.5				mA
	V _{CE} = 100 V, V _{BE} = 0				0.5			
	V _{CE} = 30 V, V _{BE} = 0, T _C = 150°C		5					
	V _{CE} = 40 V, V _{BE} = 0, T _C = 150°C			5				
	V _{CE} = 50 V, V _{BE} = 0, T _C = 150°C				5			
I _{EBO} Emitter Cutoff Current	V _{EB} = 5 V, I _C = 0,		0.5	0.5	0.5	0.5	0.5	mA
h _{FE} Static Forward Current Transfer Ratio	V _{CE} = 4 V, I _C = 5 A	25		25		25		
	V _{CE} = 4 V, I _C = 15 A	12		12		12		
	V _{CE} = 4 V, I _C = 30 A	6	30	6	30	6	30	
V _{BE} Base-Emitter Voltage	V _{CE} = 4 V, I _C = 15 A	2		2		2		V
	V _{CE} = 4 V, I _C = 30 A	4		4		4		
V _{CE(sat)} Collector-Emitter Voltage	I _B = 2 A, I _C = 15 A	1.5		1.5		1.5		V
	I _B = 7.5 A, I _C = 30 A	3		3		3		
h _{fe} Small-Signal Common-Emitter Forward Current Transfer Ratio	V _{CE} = 10 V, I _C = 1 A, f = 1 kHz	30		30		30		
h _{fe} Small-Signal Common-Emitter Forward Current Transfer Ratio	V _{CE} = 10 V, I _C = 1 A, f = 1 MHz	3		3		3		

- NOTES: 6. These parameters must be measured using pulse techniques. t_w = 300 μs, duty cycle ≤ 2%.
 7. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 3.2 mm from the device body.

*JEDEC registered data

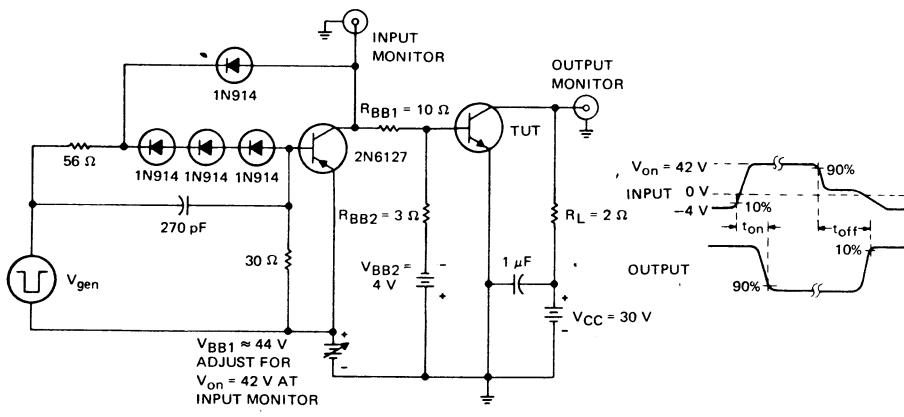
switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS†	TYP		UNIT
		0.6	0.9	
t _{on} Turn-On Time	I _C = 15 A, I _{B(1)} = 2 A, I _{B(2)} = -2 A, R _L = 2 Ω, See Figure 1			μs
t _{off} Turn-Off Time	V _{BE(off)} = -4 V,			

†Voltage and current values shown are nominal, exact values vary slightly with transistor parameters.

TYPES 2N6326, 2N6327, 2N6328 N-P-N SILICON POWER TRANSISTORS

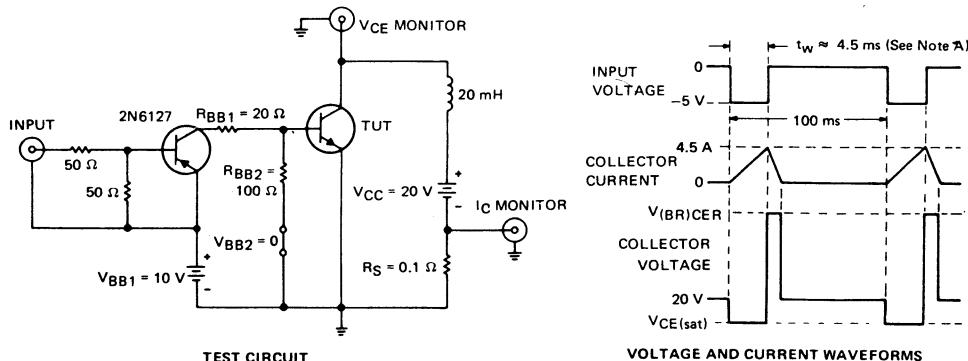
PARAMETER MEASUREMENT INFORMATION



- NOTES:**
- A. V_{gen} is a -30 V pulse (from 0 V) into a 50 Ω termination.
 - B. The V_{gen} waveform is supplied by a generator with the following characteristics: $t_r \leq 15 \text{ ns}$, $t_f \leq 15 \text{ ns}$, $Z_{out} = 50 \Omega$, $t_w = 20 \mu\text{s}$, duty cycle $\leq 2\%$.
 - C. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r \leq 15 \text{ ns}$, $R_{in} \geq 10 \text{ M}\Omega$, $C_{in} \leq 11.5 \text{ pF}$.
 - D. Resistors must be noninductive types.
 - E. The d-c power supplies may require additional bypassing in order to minimize ringing.

FIGURE 1

INDUCTIVE LOAD SWITCHING



NOTE A: Input pulse width is increased until $I_{CM} = 4.5 \text{ A}$.

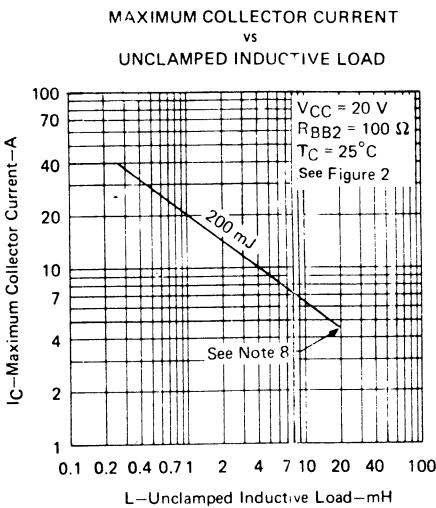
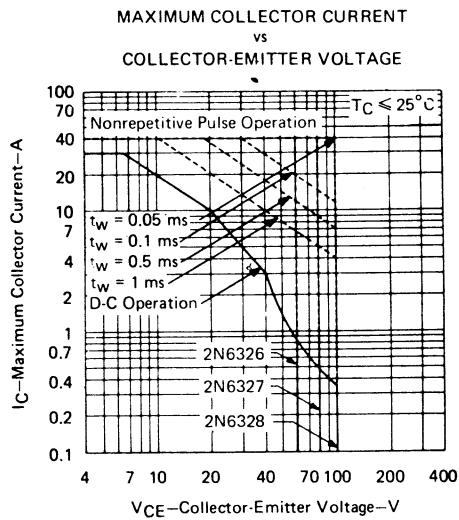
FIGURE 2

TEXAS INSTRUMENTS

TYPES 2N6326, 2N6327, 2N6328

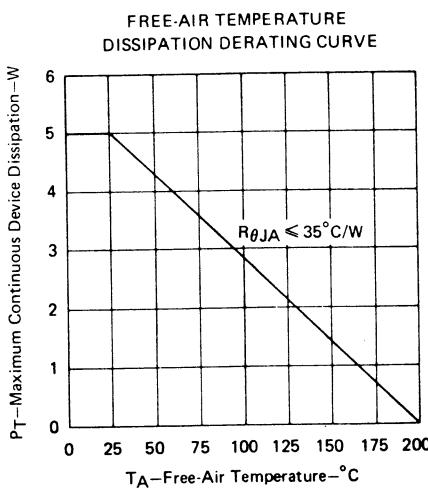
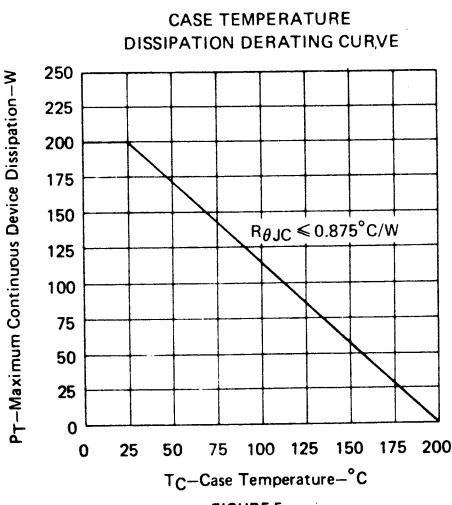
N-P-N SILICON POWER TRANSISTORS

MAXIMUM SAFE OPERATING AREAS



NOTE 8: Above this point the safe operating area has not been defined.

THERMAL INFORMATION



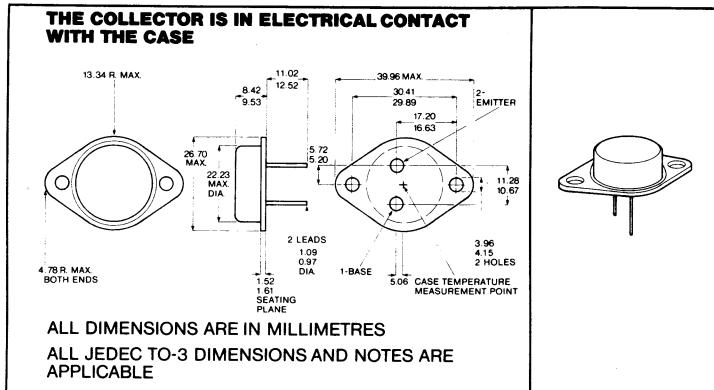
TEXAS INSTRUMENTS

**TYPES 2N6329, 2N6330, 2N6331
P-N-P SILICON POWER TRANSISTORS**

FOR POWER-AMPLIFIER AND HIGH-SPEED-SWITCHING APPLICATIONS DESIGNED FOR COMPLEMENTARY USE WITH 2N6326, 2N6327, 2N6328

- 200 W at 25°C Case Temperature
 - 30-A Rated Collector Current
 - 200-mJ Reverse Energy Rating
 - High SOA Capability, 20 V and 10 A

*mechanical data



*absolute maximum ratings at 25°C case temperature (unless otherwise noted)

	2N6329	2N6330	2N6331
Collector-Base Voltage	-60 V	-80 V	-100 V
Collector-Emitter Voltage (See Note 1)	-60 V	-80 V	-100 V
Emitter-Base Voltage	-5 V	-5 V	-5 V
Continuous Collector Current	30 A	40 A	40 A
Peak Collector Current (See Note 2)	10 A	—	—
Continuous Base Current	—	—	—
Safe Operating Areas at (or below) 25°C Case Temperature	—	—	See Figures 3 and 4
Continuous Device Dissipation at (or below) 25°C Case Temperature (See Note 3)	—	—	200 W
Continuous Device Dissipation at 100°C Case Temperature (See Note 3)	—	—	114 W
Continuous Device Dissipation at (or below) 25°C Free-Air Temperature (See Note 4)	—	—	5 W
Unclamped Inductive Load Energy (See Note 5)	—	—	200 mJ
Operating Collector Junction Temperature Range	—	—	-65°C to 200°C
Storage Temperature Range	—	—	-65°C to 200°C
Terminal Temperature 1.6mm from Case for 10 Seconds	—	—	250°C

NOTES: 1. These values apply when the base-emitter diode is open-circuited.

- This value applies for $t_{\text{FW}} \leq 1 \text{ ms}$, duty cycle $\leq 10\%$.
 - Derate linearly to 200°C case temperature at the rate of $1.14 \text{ W}^{-1}\text{C}$ or refer to Dissipation Derating Curve, Figure 5.
 - Derate linearly to 200°C free-air temperature at the rate of $28.6 \text{ mW}^{-1}\text{C}$ or refer to Dissipation Derating Curve, Figure 6.
 - This rating is based on the capability of the transistors to operate safely in the circuit of Figure 2. $L = 20 \text{ mH}$, $R_{BB2} = 100 \Omega$, $V_{BB2} = 0 \text{ V}$, $R_S = 0.1 \Omega$, $V_{CC} = 20 \text{ V}$. Energy $\approx I_C^2 L / 2$.

***JEDEC registered data. This data sheet contains all applicable registered data in effect at the time of publication.**

TEXAS INSTRUMENTS

TYPES 2N6329, 2N6330, 2N6331

P-N-P SILICON POWER TRANSISTORS

*electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	2N6329		2N6330		2N6331		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
V(BR)CEO Collector-Emitter Breakdown Voltage	I _C = -30 mA, I _B = 0, See Note 6	-60	-80	-100				V
I _{CEO} Collector Cutoff Current	V _{CE} = -30 V, I _B = 0	-1						mA
	V _{CE} = -40 V, I _B = 0		-1					
	V _{CE} = -50 V, I _B = 0			-1				
I _{CES} Collector Cutoff Current	V _{CE} = -60 V, V _{BE} = 0	-0.5						mA
	V _{CE} = -80 V, V _{BE} = 0		-0.5					
	V _{CE} = -100 V, V _{BE} = 0			-0.5				
	V _{CE} = -30 V, V _{BE} = 0, T _C = 150°C	-5						
	V _{CE} = -40 V, V _{BE} = 0, T _C = 150°C		-5					
	V _{CE} = -50 V, V _{BE} = 0, T _C = 150°C			-5				
I _{EBO} Emitter Cutoff Current	V _{EB} = -5 V, I _C = 0,	-0.5	-0.5	-0.5				mA
h _{FE} Static Forward Current Transfer Ratio	V _{CE} = -4 V, I _C = -5 A	25	25	25				
	V _{CE} = -4 V, I _C = -15 A	12	12	12				
	V _{CE} = -4 V, I _C = -30 A	6	30	6	30	6	30	
V _{BE} Base-Emitter Voltage	V _{CE} = -4 V, I _C = -15 A	-2	-2	-2				V
	V _{CE} = -4 V, I _C = -30 A	-4	-4	-4				
V _{CE(sat)} Collector-Emitter Voltage	I _B = -2 A, I _C = -15 A	-1.5	-1.5	-1.5				V
	I _B = -7.5 A, I _C = -30 A	-3	-3	-3				
h _{fe} Small-Signal Common-Emitter Forward Current Transfer Ratio	V _{CE} = -10 V, I _C = -1 A, f = 1 kHz	30	30	30				
	V _{CE} = -10 V, I _C = -1 A, f = 1 MHz	3	3	3				

NOTES: 6. These parameters must be measured using pulse techniques. t_w = 300 μs; duty cycle ≤ 2%.

7. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 3.2 mm from the device body.

*JEDEC registered data

switching characteristics at 25°C case temperature

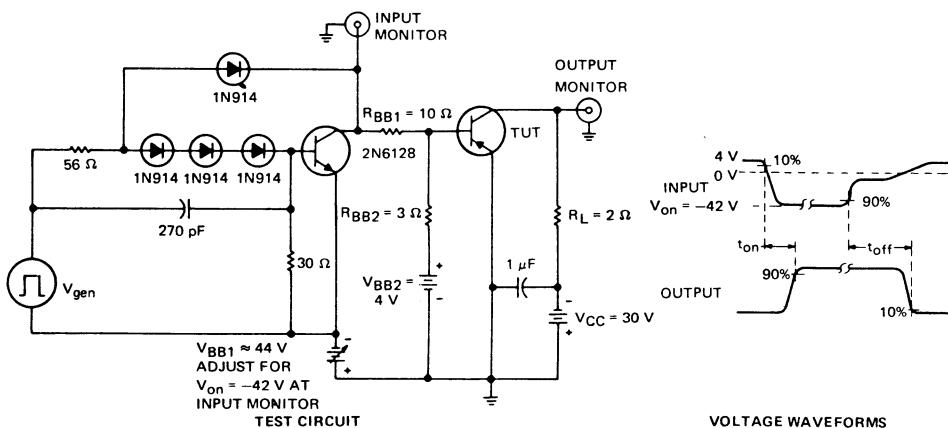
PARAMETER	TEST CONDITIONS [†]	TYP		UNIT
		0.6	0.9	
t _{on} Turn-On Time	I _C = -15 A, I _{B(1)} = -2 A, I _{B(2)} = 2 A,			μs
t _{off} Turn-Off Time	V _{BE(off)} = 4 V, R _L = 2 Ω, See Figure 1			

[†]Voltage and current values shown are nominal, exact values vary slightly with transistor parameters.

TEXAS INSTRUMENTS

TYPES 2N6329, 2N6330, 2N6331 P-N-P SILICON POWER TRANSISTORS

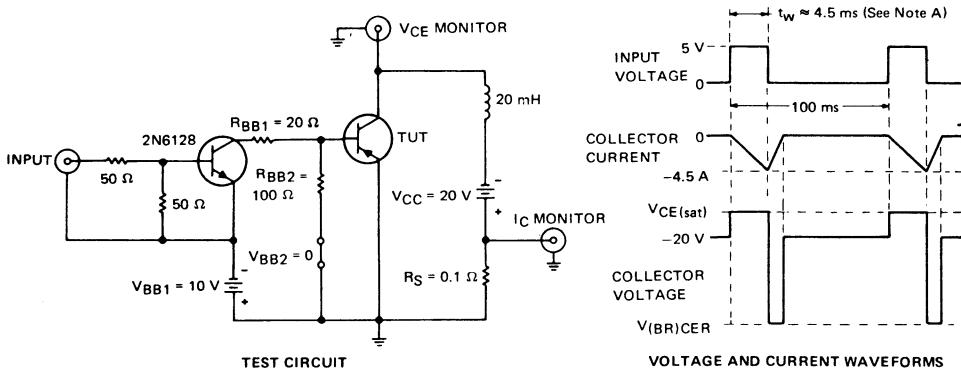
PARAMETER MEASUREMENT INFORMATION



- NOTES:**
- V_{gen} is a 30-V pulse (from 0 V) into a 50-Ω termination.
 - The V_{gen} waveform is supplied by a generator with the following characteristics: $t_r \leq 15$ ns, $t_f \leq 15$ ns, $Z_{out} = 50 \Omega$, $t_w = 20 \mu s$, duty cycle $\leq 2\%$.
 - Waveforms are monitored on an oscilloscope with the following characteristics: $t_r \leq 15$ ns, $R_{in} \geq 10 M\Omega$, $C_{in} \leq 11.5 \mu F$.
 - Resistors must be noninductive types.
 - The d.c. power supplies may require additional bypassing in order to minimize ringing.

FIGURE 1

INDUCTIVE LOAD SWITCHING



NOTE A: Input pulse width is increased until $I_{CM} = -4.5$ A.

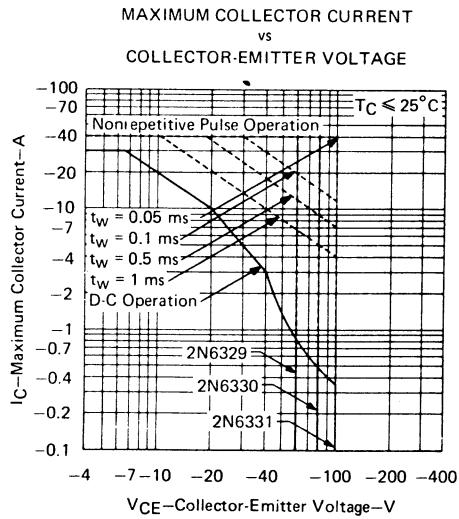
FIGURE 2

TEXAS INSTRUMENTS

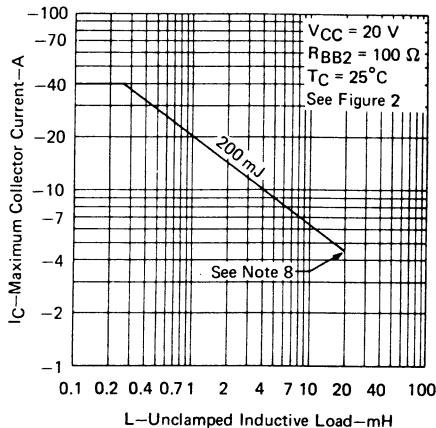
TYPES 2N6329, 2N6330, 2N6331

P-N-P SILICON POWER TRANSISTORS

MAXIMUM SAFE OPERATING AREAS

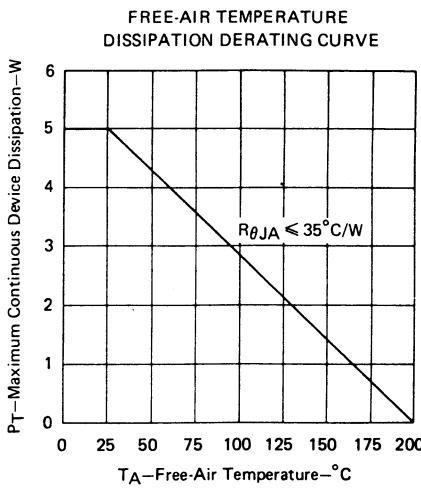
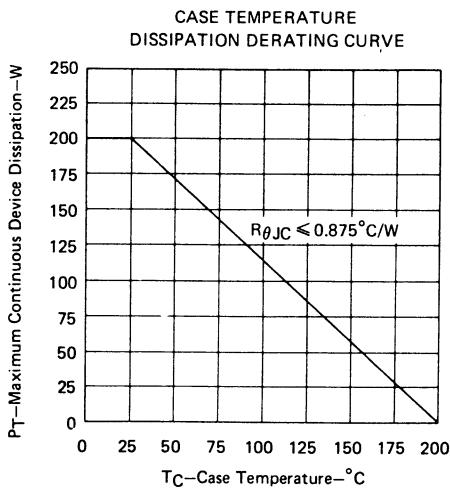


MAXIMUM COLLECTOR CURRENT
vs
UNCLAMPED INDUCTIVE LOAD



NOTE 8: Above this point the safe operating area has not been defined.

THERMAL INFORMATION



TEXAS INSTRUMENTS